

### **30V N-Channel MOSFET**

## **General Description**

The 100N03 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a wide variety of applications.

## **Features**

- Simple Drive Requirement
- Fast Switching
- Low On-Resistance

## **Product Summary**

BVDSS	RDSON	ID
30V	$3.5 m\Omega$	100A

## **Applications**

- Uninterruptible Power Supply
- DC Motor Control
- Load Switch

## **TO-252/251 Pin Configuration**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage 30		V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current 100			
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current 70		А	
I <sub>DM</sub>	Pulsed Drain Current <sup>1</sup> 300		А	
EAS	Single Pulse Avalanche Energy <sup>2</sup>	Single Pulse Avalanche Energy <sup>2</sup> 400		
P <sub>D</sub>	Total Power Dissipation 100		W	
T <sub>STG</sub>	Storage Temperature Range -55 to 175		°C	
TJ	Operating Junction Temperature Range	175	ů	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JC</sub>	Thermal Resistance Junction-case		1.36	°C/W

# CMD100N03/CMU100N03



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## Electrical Characteristics ( $T_J=25^{\circ}$ C), unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
D	Static Drain-Source On-Resistance	$V_{GS}$ =10V , $I_D$ =20A			3.5	mΩ
R <sub>DS(ON)</sub>	Static Diain-Source On-Resistance	$V_{GS}$ =5 $V$ , $I_D$ =20 $A$			6.0	11122
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1	1.6	3	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20 V$ , $V_{DS}$ = $0 V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =16V , I <sub>D</sub> =26A		45		S
$R_g$	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		2		Ω
$Q_g$	Total Gate Charge	I <sub>D</sub> =30A		70		
$Q_gs$	Gate-Source Charge	V <sub>DD</sub> =15 V		10		nC
$Q_{gd}$	Gate-Drain Charge	V <sub>GS</sub> = 10V		18		
$T_{d(on)}$	Turn-On Delay Time	V <sub>DD</sub> =15V		20		
Tr	Rise Time	I <sub>D</sub> =30A		58		ns
$T_{d(off)}$	Turn-Off Delay Time	R <sub>G</sub> =12Ω		120		115
T <sub>f</sub>	Fall Time	V <sub>GS</sub> =10V		90		
C <sub>iss</sub>	Input Capacitance			5500		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		950		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			260		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			100	Α
I <sub>SM</sub>	Pulsed Source Current				300	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.2	V

#### Note

This product has been designed and qualified for the counsumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserver the right to improve product design ,functions and reliability wihtout notice.

<sup>1.</sup>Repetitive rating; pulse width limited by maximum junction temperature

<sup>2.</sup>The test condition is VDD=15V,L=0.5mH,ID=40A